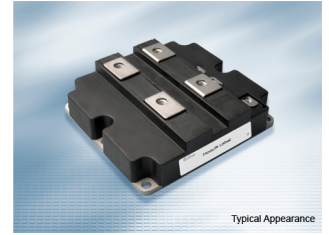


IHM-B module with Trench/Fieldstop IGBT4 and emitter controlled 4 diode

Features

- Electrical features
 - $V_{CES} = 3300\text{ V}$
 - $I_{C\text{nom}} = 1600\text{ A} / I_{CRM} = 3200\text{ A}$
 - High DC stability
 - High short-circuit capability
 - Low switching losses
 - Low $V_{CE,sat}$
 - $T_{vj,op} = 150^{\circ}\text{C}$
 - Trench IGBT 4
 - Unbeatable robustness
 - $V_{CE,sat}$ with positive temperature coefficient
 - High current density
 - Low Q_g and C_{res}
- Mechanical features
 - ALSiC base plate for increased thermal cycling capability
 - High power density
 - Isolated base plate
 - Package with CTI > 600
 - RoHS compliant



Potential applications

- High-power converters
- Medium-voltage converters
- Motor drives
- Traction drives
- UPS systems
- Active frontend (energy recovery)

Product validation

- Qualified for industrial applications according to the relevant tests of IEC 60747, 60749 and 60068

Description

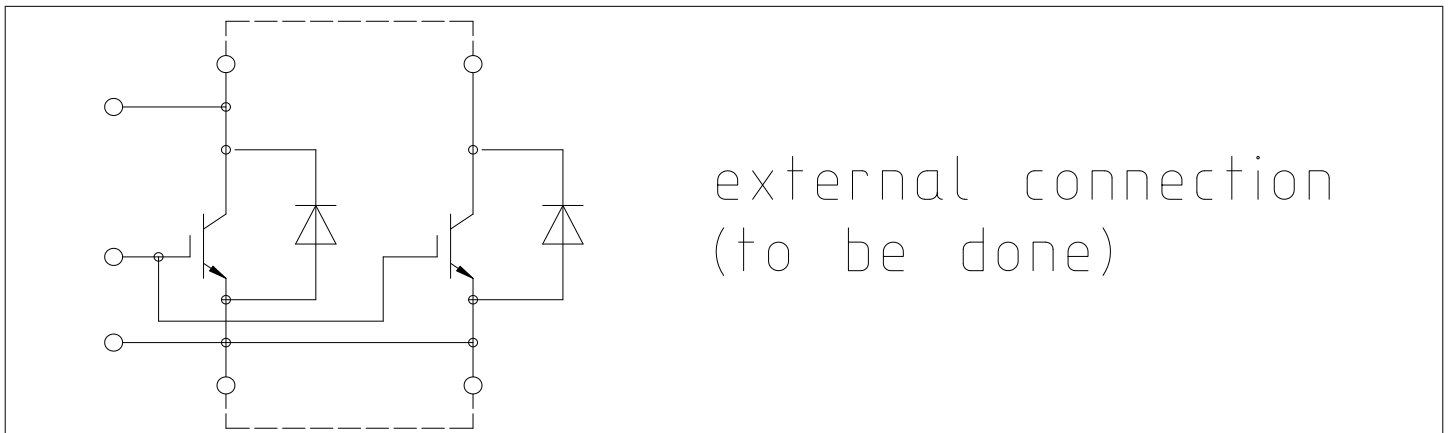


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1 Package

Table 1 Insulation coordination

| Parameter | Symbol | Note or test condition | Values | Unit |
|--------------------------------------|-------------|--------------------------------------------------------|--------|------|
| Isolation test voltage | V_{ISOL} | RMS, $f = 50 \text{ Hz}$, $t = 60 \text{ s}$ | 6.0 | kV |
| Partial discharge extinction voltage | V_{isol} | RMS, $f = 50 \text{ Hz}$, $Q_{PD} \leq 10 \text{ pC}$ | 2.6 | kV |
| DC stability | $V_{CE(D)}$ | $T_{vj} = 25 \text{ }^\circ\text{C}$, 100 Fit | 2100 | V |
| Material of module baseplate | | | AlSiC | |
| Creepage distance | d_{Creep} | terminal to heatsink | 32.2 | mm |
| Clearance | d_{Clear} | terminal to heatsink | 19.1 | mm |
| Comparative tracking index | CTI | | > 600 | |

Table 2 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit | |
|------------------------------------------|---------------|------------------------------------------------|-----------|------|------|------------------|----|
| | | | Min. | Typ. | Max. | | |
| Stray inductance module | L_{sCE} | | | 9 | | nH | |
| Module lead resistance, terminals - chip | $R_{AA'+CC'}$ | $T_C = 25 \text{ }^\circ\text{C}$, per switch | | 0.12 | | m Ω | |
| Module lead resistance, terminals - chip | $R_{CC'+EE'}$ | $T_C = 25 \text{ }^\circ\text{C}$, per switch | | 0.14 | | m Ω | |
| Storage temperature | T_{stg} | | -40 | | 150 | $^\circ\text{C}$ | |
| Mounting torque for module mounting | M | - Mounting according to valid application note | M6, Screw | 4.25 | | 5.75 | Nm |
| Terminal connection torque | M | - Mounting according to valid application note | M4, Screw | 1.8 | | 2.1 | Nm |
| | | | M8, Screw | 8 | | 10 | |
| Weight | G | | | 800 | | g | |

2 IGBT, Inverter

Table 3 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|-----------------------------------|-----------|---------------------------------------------------|---------------------------------------|------|---|
| Collector-emitter voltage | V_{CES} | | $T_{vj} = -40 \text{ }^\circ\text{C}$ | 3300 | V |
| | | | $T_{vj} = 150 \text{ }^\circ\text{C}$ | 3300 | |
| Continuous DC collector current | I_{CDC} | $T_{vj \text{ max}} = 150 \text{ }^\circ\text{C}$ | $T_C = 100 \text{ }^\circ\text{C}$ | 1600 | A |
| Repetitive peak collector current | I_{CRM} | t_p limited by $T_{vj \text{ op}}$ | | 3200 | A |

(table continues...)

Table 3 (continued) Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit |
|---------------------------|-----------|------------------------|--------|------|
| Gate-emitter peak voltage | V_{GES} | | ±20 | V |

Table 4 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|--------------------------------------|---------------|-------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------|-------|------|----------|
| | | | Min. | Typ. | Max. | |
| Collector-emitter saturation voltage | $V_{CE\ sat}$ | $I_C = 1600\ A, V_{GE} = 15\ V$ | $T_{vj} = 25\ ^\circ C$ | 2.40 | 2.65 | V |
| | | | $T_{vj} = 125\ ^\circ C$ | 2.95 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | 3.10 | 3.25 | |
| Gate threshold voltage | V_{GEth} | $I_C = 62\ mA, V_{CE} = V_{GE}, T_{vj} = 25\ ^\circ C$ | 5.20 | 5.80 | 6.40 | V |
| Gate charge | Q_G | $V_{GE} = \pm 15\ V, V_{CC} = 1800\ V$ | | 28 | | μC |
| Internal gate resistor | R_{Gint} | $T_{vj} = 25\ ^\circ C$ | | 0.75 | | Ω |
| Input capacitance | C_{ies} | $f = 1000\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$ | | 187 | | nF |
| Reverse transfer capacitance | C_{res} | $f = 1000\ kHz, T_{vj} = 25\ ^\circ C, V_{CE} = 25\ V, V_{GE} = 0\ V$ | | 5.33 | | nF |
| Collector-emitter cut-off current | I_{CES} | $V_{CE} = 3300\ V, V_{GE} = 0\ V$ | $T_{vj} = 25\ ^\circ C$ | | 5 | mA |
| Gate-emitter leakage current | I_{GES} | $V_{CE} = 0\ V, V_{GE} = 20\ V, T_{vj} = 25\ ^\circ C$ | | | 400 | nA |
| Turn-on delay time (inductive load) | t_{don} | $I_C = 1600\ A, V_{CC} = 1800\ V, V_{GE} = \pm 15\ V, R_{Gon} = 0.8\ \Omega$ | $T_{vj} = 25\ ^\circ C$ | 0.600 | | μs |
| | | | $T_{vj} = 125\ ^\circ C$ | 0.710 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | 0.760 | | |
| Rise time (inductive load) | t_r | $I_C = 1600\ A, V_{CC} = 1800\ V, V_{GE} = \pm 15\ V, R_{Gon} = 0.8\ \Omega$ | $T_{vj} = 25\ ^\circ C$ | 0.220 | | μs |
| | | | $T_{vj} = 125\ ^\circ C$ | 0.240 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | 0.250 | | |
| Turn-off delay time (inductive load) | t_{doff} | $I_C = 1600\ A, V_{CC} = 1800\ V, V_{GE} = \pm 15\ V, R_{Goff} = 3.9\ \Omega$ | $T_{vj} = 25\ ^\circ C$ | 3.420 | | μs |
| | | | $T_{vj} = 125\ ^\circ C$ | 3.670 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | 3.740 | | |
| Fall time (inductive load) | t_f | $I_C = 1600\ A, V_{CC} = 1800\ V, V_{GE} = \pm 15\ V, R_{Goff} = 3.9\ \Omega$ | $T_{vj} = 25\ ^\circ C$ | 0.690 | | μs |
| | | | $T_{vj} = 125\ ^\circ C$ | 1.290 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | 1.470 | | |
| Turn-on time (resistive load) | t_{on_R} | $I_C = 500\ A, V_{CC} = 2000\ V, V_{GE} = \pm 15\ V, R_{Gon} = 0.8\ \Omega$ | $T_{vj} = 25\ ^\circ C$ | 1.18 | | μs |
| Turn-on energy loss per pulse | E_{on} | $I_C = 1600\ A, V_{CC} = 1800\ V, L_\sigma = 85\ nH, V_{GE} = \pm 15\ V, R_{Gon} = 0.8\ \Omega, di/dt = 5300\ A/\mu s (T_{vj} = 150\ ^\circ C)$ | $T_{vj} = 25\ ^\circ C$ | 1850 | | mJ |
| | | | $T_{vj} = 125\ ^\circ C$ | 2850 | | |
| | | | $T_{vj} = 150\ ^\circ C$ | 3200 | | |

(table continues...)

Table 4 (continued) Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit |
|----------------------------------------|------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------|------|------|------------------|
| | | | Min. | Typ. | Max. | |
| Turn-off energy loss per pulse | E_{off} | $I_C = 1600\text{ A}, V_{CC} = 1800\text{ V}, L_\sigma = 85\text{ nH}, V_{GE} = \pm 15\text{ V}, R_{Goff} = 3.9\ \Omega, dv/dt = 1700\text{ V}/\mu\text{s} (T_{vj} = 150\text{ }^\circ\text{C})$ | $T_{vj} = 25\text{ }^\circ\text{C}$ | 2280 | | mJ |
| | | | $T_{vj} = 125\text{ }^\circ\text{C}$ | 2980 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C}$ | 3140 | | |
| SC data | I_{SC} | $V_{GE} \leq 15\text{ V}, V_{CC} = 2400\text{ V}, V_{CEmax} = V_{CES} - L_{sCE} * di/dt$ | $t_p \leq 10\ \mu\text{s}, T_{vj} \leq 150\text{ }^\circ\text{C}$ | 6400 | | A |
| Thermal resistance, junction to case | R_{thJC} | per IGBT | | | 9.30 | K/kW |
| Thermal resistance, case to heat sink | R_{thCH} | per IGBT | | 5.60 | | K/kW |
| Temperature under switching conditions | T_{vjop} | | -40 | | 150 | $^\circ\text{C}$ |

3 Diode, Inverter

Table 5 Maximum rated values

| Parameter | Symbol | Note or test condition | Values | Unit | |
|---------------------------------|-------------|----------------------------------------|--------------------------------------|---------------|-------------------|
| Repetitive peak reverse voltage | V_{RRM} | | $T_{vj} = -40\text{ }^\circ\text{C}$ | 3300 | V |
| | | | $T_{vj} = 150\text{ }^\circ\text{C}$ | 3300 | |
| Continuous DC forward current | I_F | | 1600 | A | |
| Repetitive peak forward current | I_{FRM} | $t_p = 1\text{ ms}$ | 3200 | A | |
| I^2t - value | I^2t | $t_p = 10\text{ ms}, V_R = 0\text{ V}$ | $T_{vj} = 125\text{ }^\circ\text{C}$ | 630 | kA ² s |
| | | | $T_{vj} = 150\text{ }^\circ\text{C}$ | 570 | |
| Maximum power dissipation | P_{RQM} | | $T_{vj} = 150\text{ }^\circ\text{C}$ | 3600 | kW |
| Minimum turn-on time | t_{onmin} | | 10 | μs | |

Table 6 Characteristic values

| Parameter | Symbol | Note or test condition | Values | | | Unit | |
|-----------------|--------|--------------------------------------------|--------------------------------------|------|------|------|---|
| | | | Min. | Typ. | Max. | | |
| Forward voltage | V_F | $I_F = 1600\text{ A}, V_{GE} = 0\text{ V}$ | $T_{vj} = 25\text{ }^\circ\text{C}$ | | 2.90 | 3.30 | V |
| | | | $T_{vj} = 125\text{ }^\circ\text{C}$ | | 2.60 | | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C}$ | | 2.50 | 2.80 | |

(table continues...)

Table 6 (continued) Characteristic values

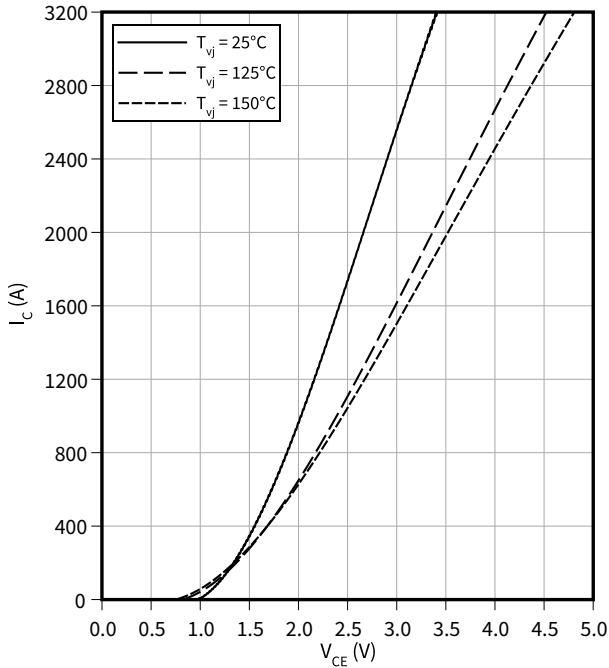
| Parameter | Symbol | Note or test condition | Values | | | Unit |
|----------------------------------------|--------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------|--------------------------------------|------|------|------------------|
| | | | Min. | Typ. | Max. | |
| Peak reverse recovery current | I_{RM} | $V_{CC} = 1800\text{ V}$, $I_F = 1600\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 5300\text{ A}/\mu\text{s}$ ($T_{vj} = 150\text{ }^\circ\text{C}$) | $T_{vj} = 25\text{ }^\circ\text{C}$ | | 1470 | A |
| | | | $T_{vj} = 125\text{ }^\circ\text{C}$ | | 1650 | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C}$ | | 1700 | |
| Recovered charge | Q_r | $V_{CC} = 1800\text{ V}$, $I_F = 1600\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 5300\text{ A}/\mu\text{s}$ ($T_{vj} = 150\text{ }^\circ\text{C}$) | $T_{vj} = 25\text{ }^\circ\text{C}$ | | 685 | μC |
| | | | $T_{vj} = 125\text{ }^\circ\text{C}$ | | 1360 | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C}$ | | 2000 | |
| Reverse recovery energy | E_{rec} | $V_{CC} = 1800\text{ V}$, $I_F = 1600\text{ A}$, $V_{GE} = -15\text{ V}$, $-di_F/dt = 5300\text{ A}/\mu\text{s}$ ($T_{vj} = 150\text{ }^\circ\text{C}$) | $T_{vj} = 25\text{ }^\circ\text{C}$ | | 730 | mJ |
| | | | $T_{vj} = 125\text{ }^\circ\text{C}$ | | 1450 | |
| | | | $T_{vj} = 150\text{ }^\circ\text{C}$ | | 1750 | |
| Thermal resistance, junction to case | R_{thJC} | per diode | | | 17.5 | K/kW |
| Thermal resistance, case to heat sink | R_{thCH} | per diode | | 8.50 | | K/kW |
| Temperature under switching conditions | $T_{vj\text{ op}}$ | | -40 | | 150 | $^\circ\text{C}$ |

4 Characteristics diagrams

Output characteristic (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

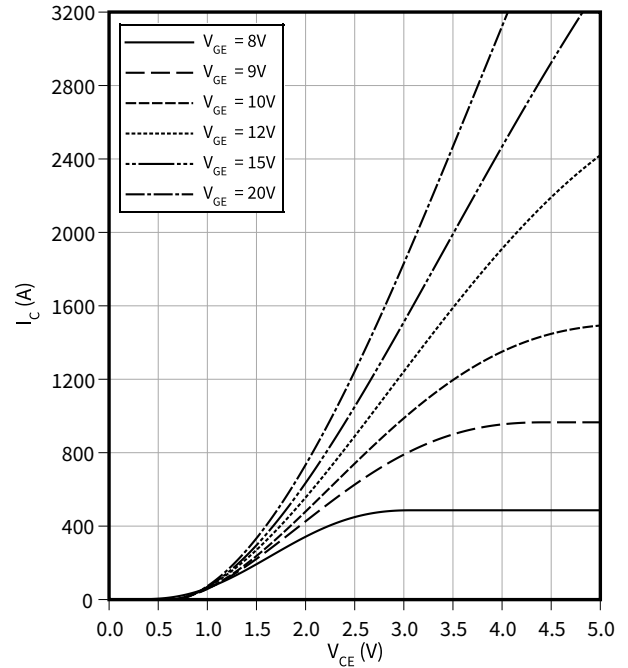
$$V_{GE} = 15 \text{ V}$$



Output characteristic field (typical), IGBT, Inverter

$$I_C = f(V_{CE})$$

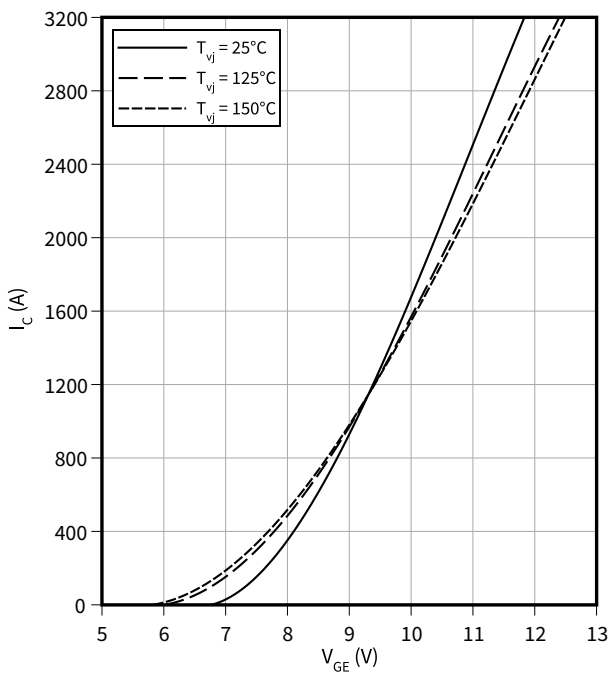
$$T_{vj} = 150 \text{ °C}$$



Transfer characteristic (typical), IGBT, Inverter

$$I_C = f(V_{GE})$$

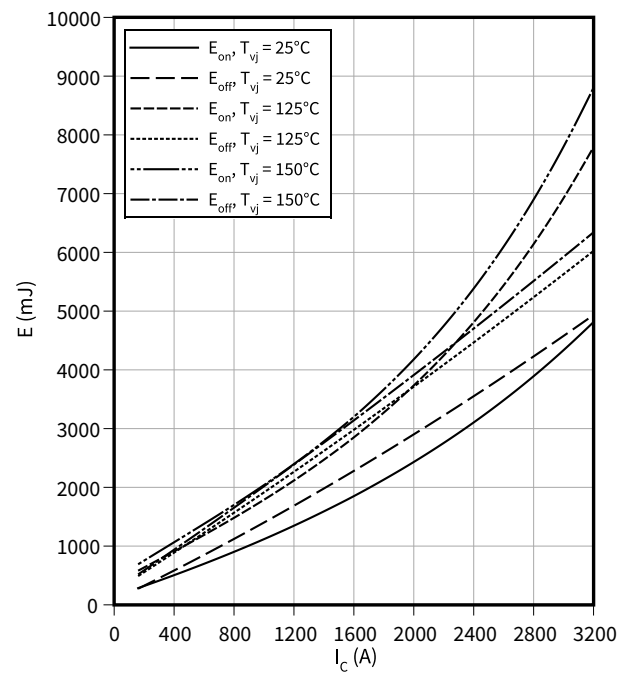
$$V_{CE} = 20 \text{ V}$$



Switching losses (typical), IGBT, Inverter

$$E = f(I_C)$$

$$R_{Goff} = 3.9 \text{ } \Omega, R_{Gon} = 0.8 \text{ } \Omega, V_{CC} = 1800 \text{ V}, V_{GE} = \pm 15 \text{ V}$$

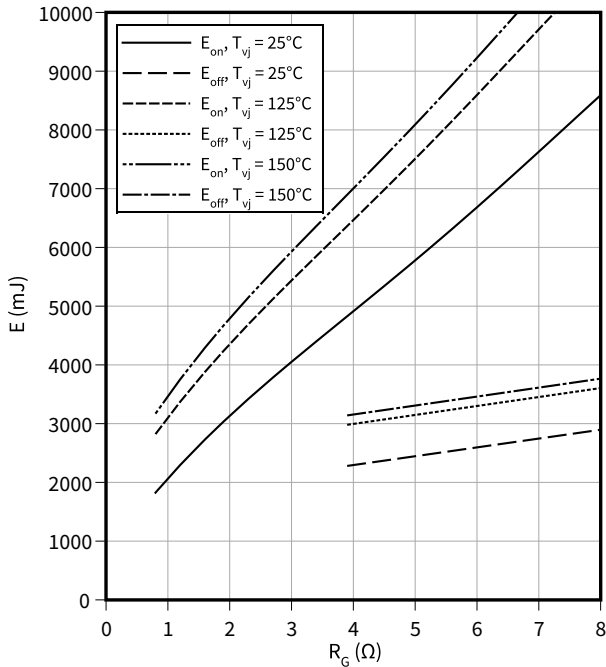


4 Characteristics diagrams

Switching losses (typical), IGBT, Inverter

$E = f(R_G)$

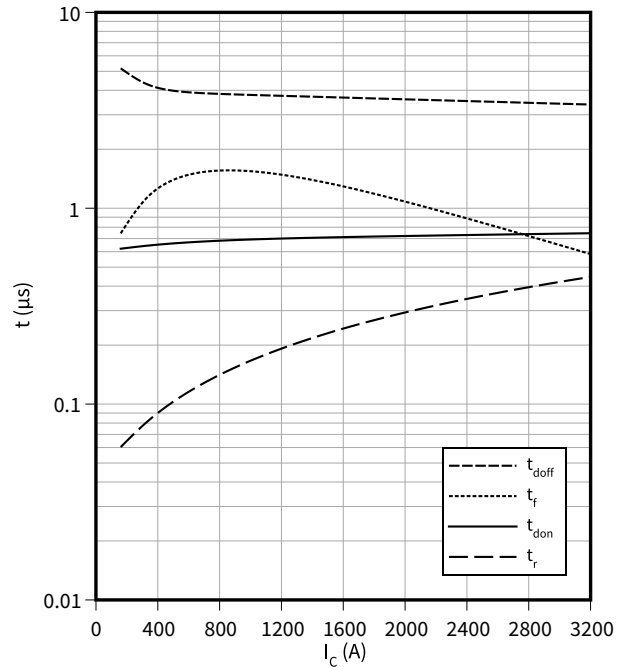
$I_C = 1600 \text{ A}, V_{CC} = 1800 \text{ V}, V_{GE} = \pm 15 \text{ V}$



Switching times (typical), IGBT, Inverter

$t = f(I_C)$

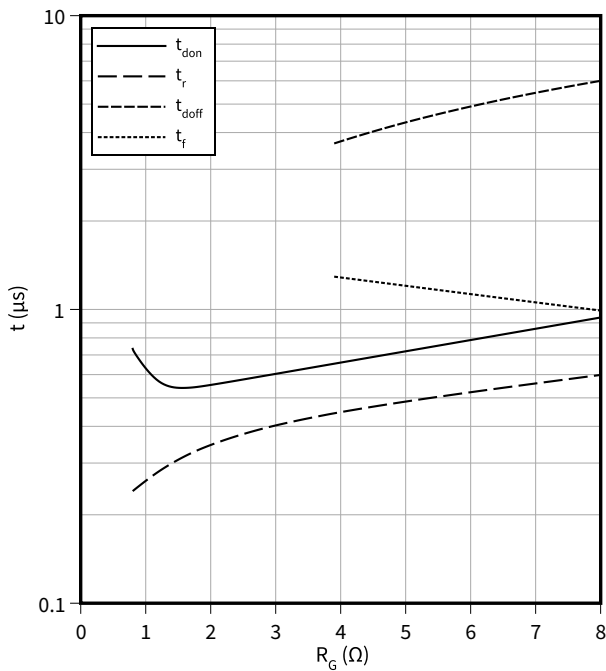
$R_{Goff} = 3.9 \Omega, R_{Gon} = 0.8 \Omega, V_{CC} = 1800 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 125^\circ\text{C}$



Switching times (typical), IGBT, Inverter

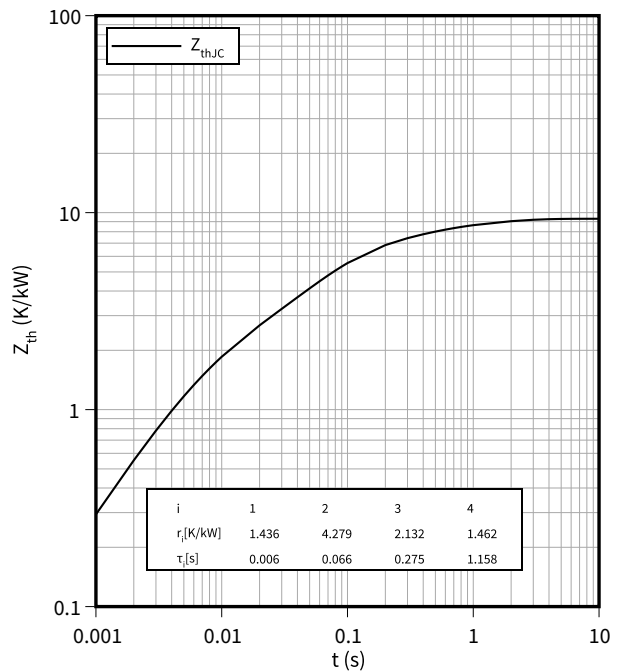
$t = f(R_G)$

$I_C = 1600 \text{ A}, V_{CC} = 1800 \text{ V}, V_{GE} = \pm 15 \text{ V}, T_{vj} = 125^\circ\text{C}$



Transient thermal impedance, IGBT, Inverter

$Z_{th} = f(t)$

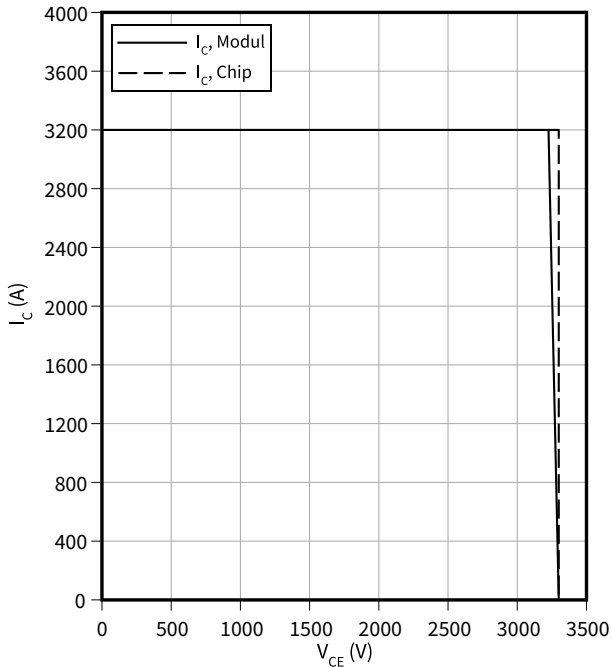


4 Characteristics diagrams

Reverse bias safe operating area (RBSOA), IGBT, Inverter

$I_C = f(V_{CE})$

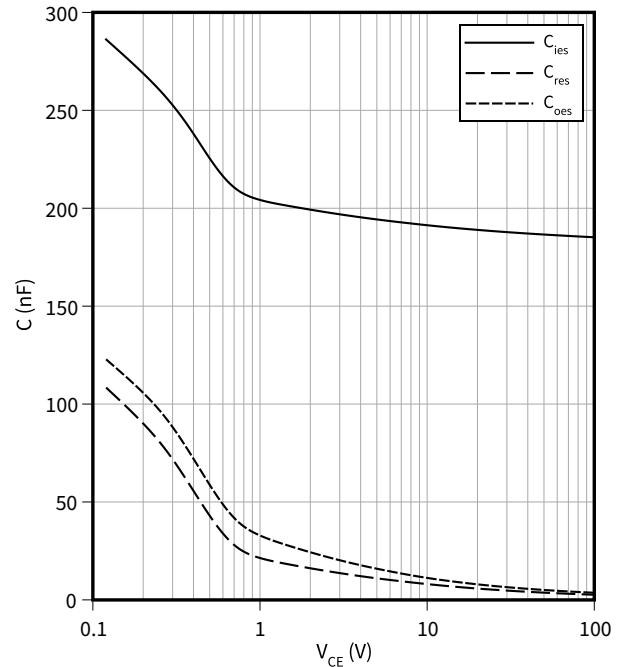
$R_{Goff} = 3.9 \Omega, V_{GE} = \pm 15 \text{ V}, T_{vj} = 150 \text{ }^\circ\text{C}$



Capacity characteristic (typical), IGBT, Inverter

$C = f(V_{CE})$

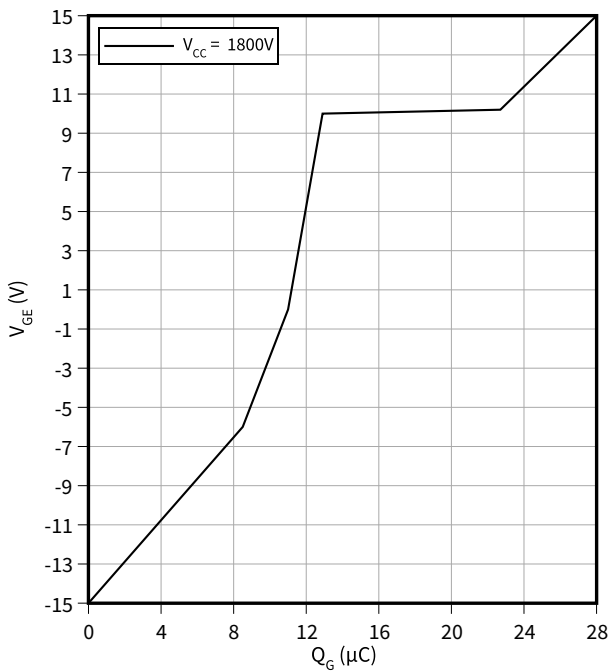
$f = 100 \text{ kHz}, V_{GE} = 0 \text{ V}, T_{vj} = 25 \text{ }^\circ\text{C}$



Gate charge characteristic (typical), IGBT, Inverter

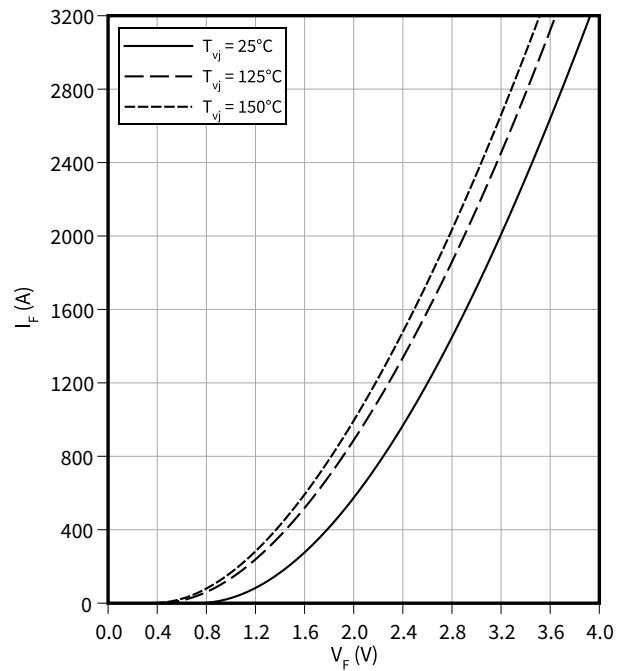
$V_{GE} = f(Q_G)$

$I_C = 1600 \text{ A}, T_{vj} = 25 \text{ }^\circ\text{C}$



Forward characteristic (typical), Diode, Inverter

$I_F = f(V_F)$

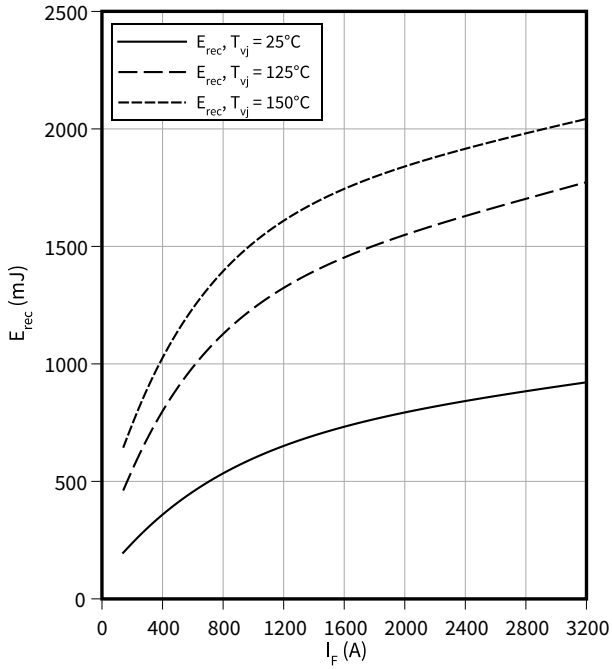


4 Characteristics diagrams

Switching losses (typical), Diode, Inverter

$E_{rec} = f(I_F)$

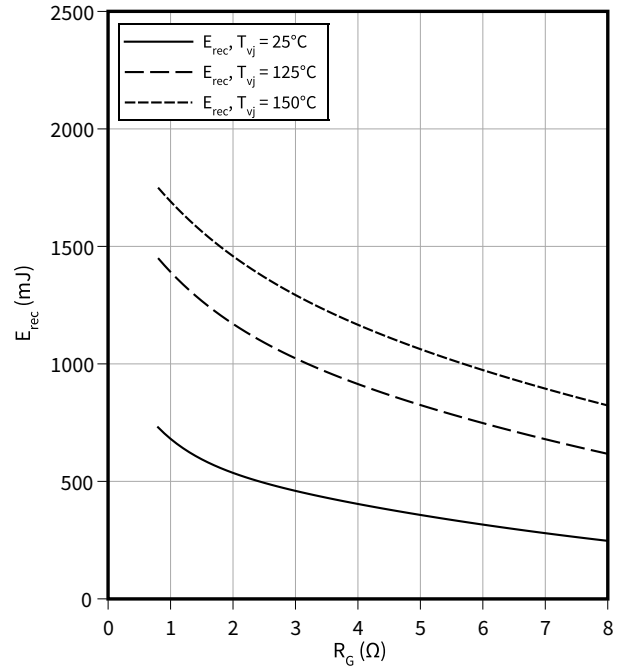
$V_{CE} = 1800\text{ V}$, $R_{Gon} = R_{Gon}(IGBT)$



Switching losses (typical), Diode, Inverter

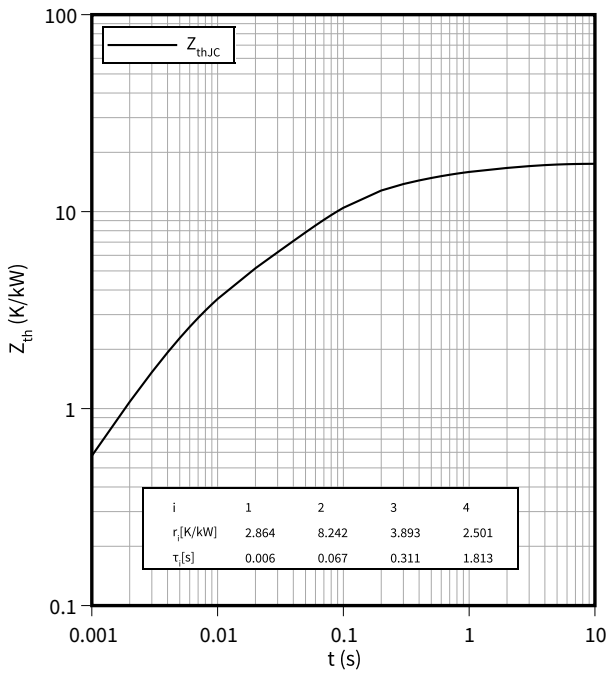
$E_{rec} = f(R_G)$

$V_{CE} = 1800\text{ V}$, $I_F = 1600\text{ A}$



Transient thermal impedance, Diode, Inverter

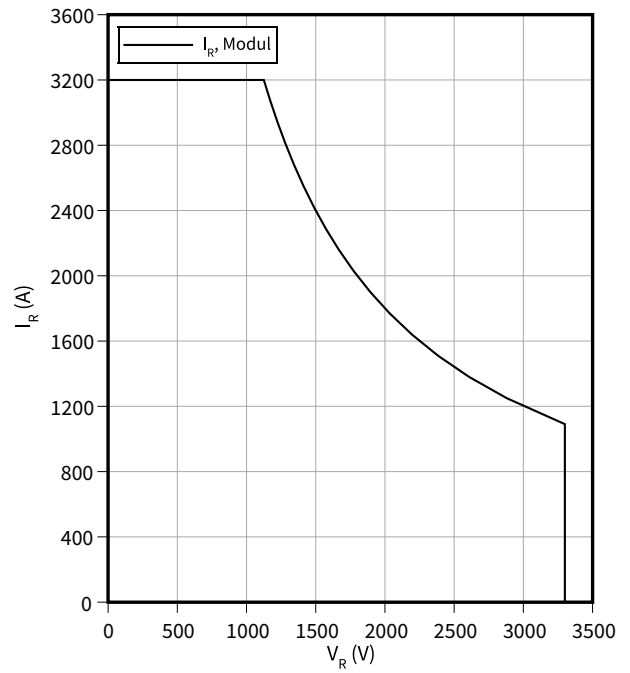
$Z_{th} = f(t)$



Safe operating area (SOA), Diode, Inverter

$I_R = f(V_R)$

$T_{vj} = 150^\circ\text{C}$



5 Circuit diagram

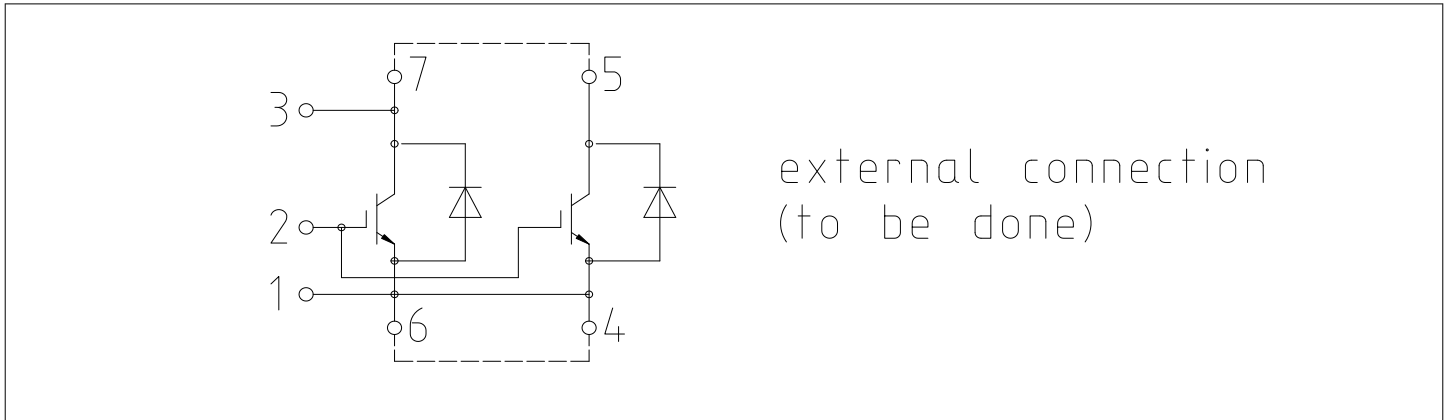


Figure 1

6 Package outlines

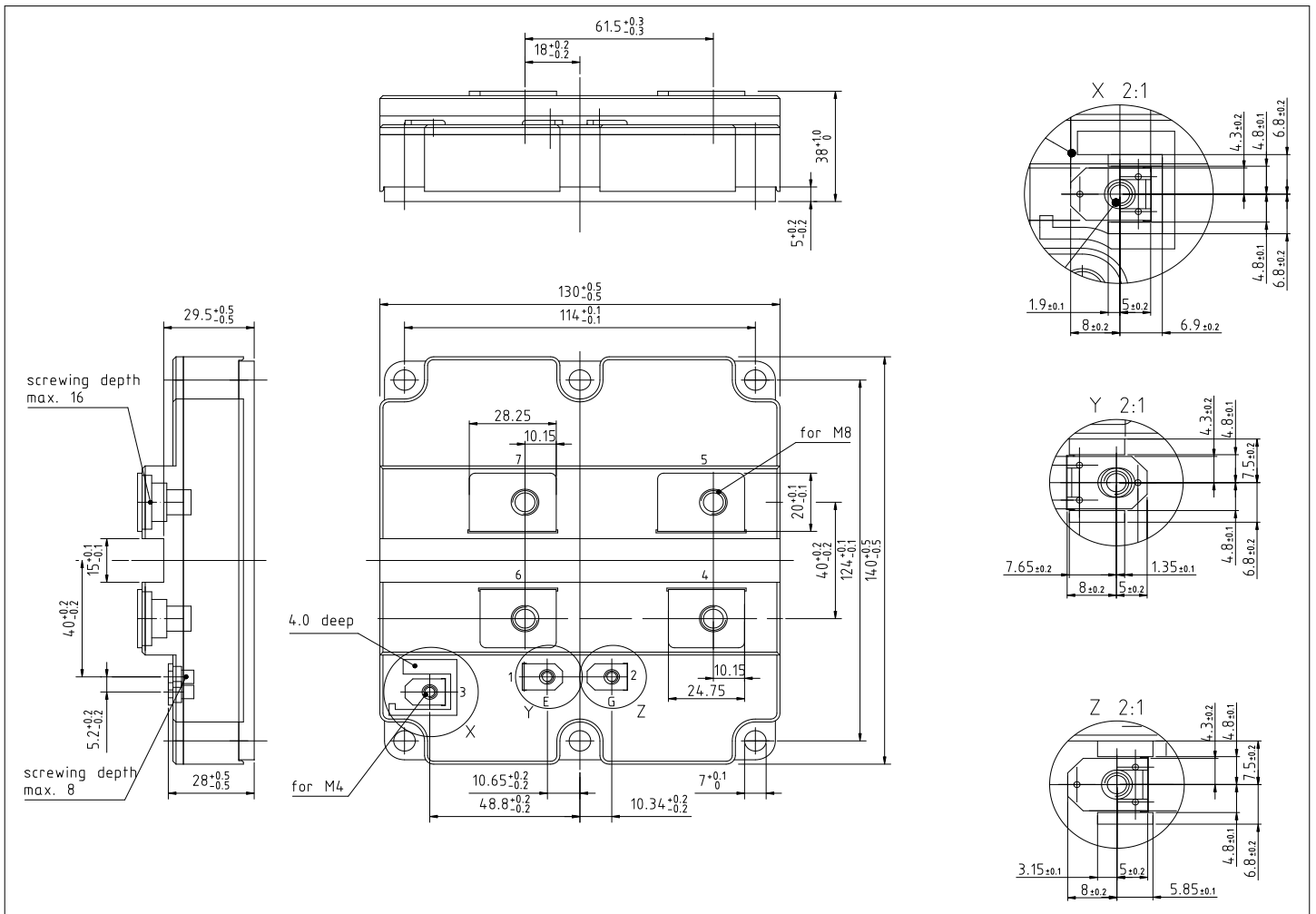


Figure 2

7 Module label code


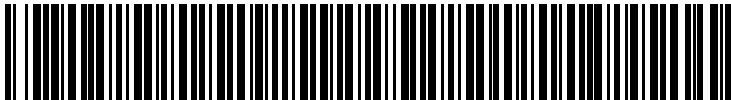
| Module label code | | | |
|--------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------|---------------------------------------------------------------|
| Code format | Data Matrix | Barcode Code128 | |
| Encoding | ASCII text | Code Set A | |
| Symbol size | 16x16 | 23 digits | |
| Standard | IEC24720 and IEC16022 | IEC8859-1 | |
| Code content | <i>Content</i> Module serial number Module material number Production order number Date code (production year) Date code (production week) | <i>Digit</i> 1 - 5 6 - 11 12 - 19 20 - 21 22 - 23 | <i>Example</i> 71549 142846 55054991 15 30 |
| Example |   | | <p>71549142846550549911530</p> <p>71549142846550549911530</p> |

Figure 3

Revision history

| Document revision | Date of release | Description of changes |
|-------------------|-----------------|------------------------|
| 1.00 | 2021-03-02 | |
| 1.10 | 2021-04-13 | Final |
| 1.20 | 2021-10-28 | Final datasheet |
| 1.30 | 2022-11-22 | Final datasheet |

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